## Surface Mount

# Power Splitter/Combiner SBTC-2-15-75+

2 Way-0° 500 to 1500 MHz  $75\Omega$ 

#### **Features**

- low insertion loss, 0.8 dB typ.
- high isolation, 28 dB typ.
- very good phase unbalance, 1.0 deg. typ.
- temperature stable LTCC base
- small size
- · low cost
- aqueous washable
- protected by US patent 6,963,255

#### **Applications**

- internet over satellite modems
- VSAT





Generic photo used for illustration purposes only CASE STYLE: AT790

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



#### **Electrical Specifications**

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit
Frequency Range		500		1500	MHz
Insertion Loss Above 3.0 dB	500 - 1500	_	0.8	1.5	dB
Insertion coss Above 3.0 db	750 - 1500	_	0.8	1.5	U.D
Isolation	500 - 1500	18	28	_	dB
Isolation	750 - 1500	20	28	_	αв
Phase Unbalance	500 - 1500	_	_	5	Dograo
Phase Oribalance	750 - 1500	_	_	4	Degree
Amplitude Unbelgnes	500 - 1500	_	_	0.9	dB
Amplitude Unbalance	750 - 1500	_	_	0.7	uБ

#### **Maximum Ratings**

Parameter	Ratings						
Operating Temperature	-40°C to 85°C						
Storage Temperature	-55°C to 100°C						
Power Input (as a splitter)	0.5W max.						
Internal Dissipation	0.125W max.						

Permanent damage may occur if any of these limits are exceeded.

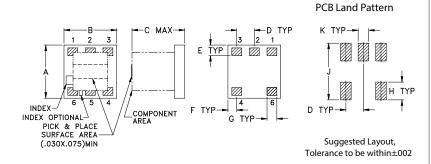
#### **Pin Connections**

Function	Pin Number
SUM PORT	6
PORT 1	3
PORT 2	4
GROUND	1,2
NOT USED	5

#### **Electrical Schematic**



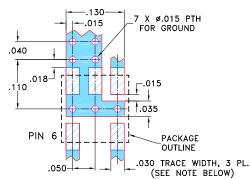
#### **Outline Drawing**



#### Outline Dimensions (inch )

wt	K	J	Н	G	F	E	D	С	В	Α
grams	.030	.160	.050	.028	.025	.030	.050	.150	.150	.150
0.10	0.76	4.06	1.27	0.71	0.64	0.76	1.27	3.81	3.81	3.81

#### Demo Board MCL P/N: TB-277 Suggested PCB Layout (PL-153)



NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER

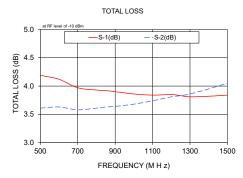
MASK OVER BARE COPPER)

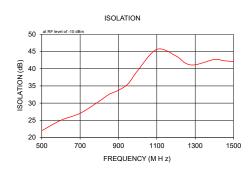
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

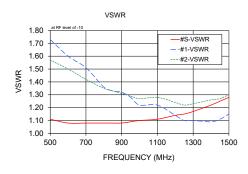
#### **Typical Performance Data**

Frequency (MHz)	Total (d	В)	Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR S	VSWR 1	VSWR 2
	S-1	S-2						
500.00	4.19	3.61	0.58	21.98	1.92	1.11	1.73	1.57
600.00	4.12	3.63	0.49	25.03	1.30	1.08	1.60	1.50
700.00	3.97	3.58	0.39	27.04	0.91	1.08	1.51	1.42
800.00	3.93	3.61	0.32	30.56	0.59	1.08	1.36	1.35
850.00	3.92	3.63	0.29	32.53	0.44	1.08	1.33	1.33
900.00	3.90	3.64	0.25	33.74	0.29	1.08	1.32	1.31
950.00	3.88	3.66	0.22	35.62	0.20	1.09	1.28	1.29
1000.00	3.86	3.68	0.18	39.45	0.15	1.10	1.22	1.27
1100.00	3.84	3.74	0.10	45.64	0.17	1.11	1.22	1.28
1200.00	3.85	3.81	0.04	43.71	0.19	1.14	1.14	1.24
1250.00	3.83	3.83	0.03	41.60	0.21	1.15	1.10	1.22
1300.00	3.81	3.86	0.05	41.15	0.19	1.17	1.10	1.23
1400.00	3.82	3.95	0.13	42.70	0.21	1.22	1.09	1.26
1450.00	3.83	4.00	0.17	42.33	0.24	1.25	1.11	1.27
1500.00	3.84	4.05	0.21	42.11	0.30	1.28	1.15	1.30

1. Total Loss = Insertion Loss + 3dB splitter loss







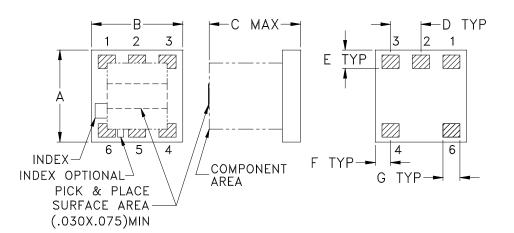
#### **Additional Notes**

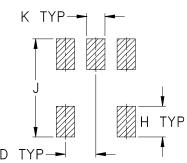
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
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## **Outline Dimensions**

AT790

### **PCB Land Pattern**





Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	С	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT790	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.050 (1.27)	.160 (4.06)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

#### **Notes:**

- 1. Open style, Ceramic base.
- 2. Termination finish: Palladium Silver.



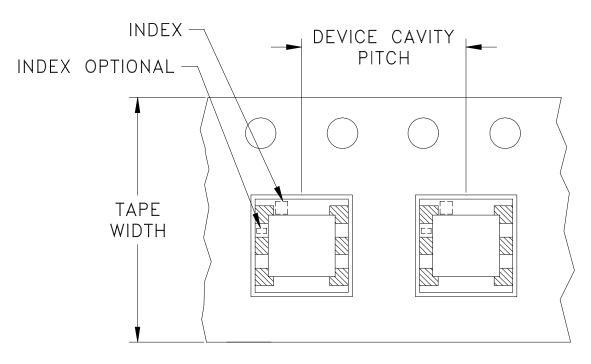


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## Tape & Reel Packaging TR-F15

## DEVICE ORIENTATION IN T&R



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
			20
			50
		7	100
12	8		200
			500
		13	1000
			2000

**Note**: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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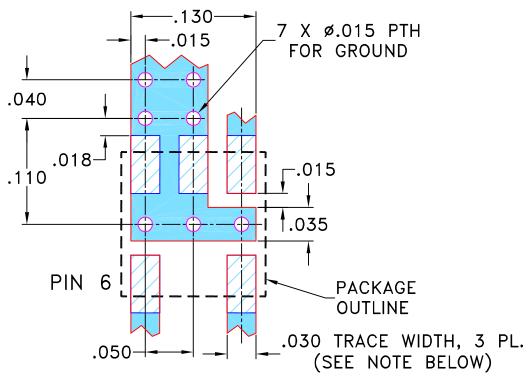
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<b>*</b>	

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M90457	NEW RELEASE	01/16/04	AV	WP
A	M102713	ADDED "WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION FOR AT1029 CASE STYLE, "nc" PIN CONNECTION



- NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030"  $\pm$  0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
  - 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

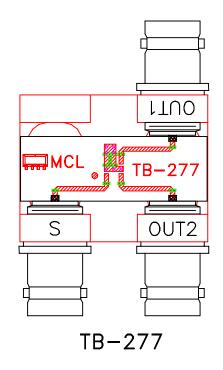
    DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER

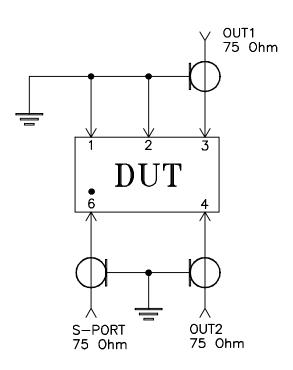
    MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE		¬ ¬ * • •		• 4 R	
DIMENSIONS ARE IN INCHES	DRAWN	AV	01/07/04		⊔ Mını	i–Circu	Its 13 N	eptune Avenue klyn NY 11235
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	IL	01/16/04				Brook	myn Ni 11235
3 PL DECIMALS ± .005	APPROVED	WP	01/16/04					
FRACTIONS ±				PL.	nc. 75	, AT1029,	SBTC.	TB - 277
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## Evaluation Board and Circuit





Schematic Diagram

## Notes:

- 1. 75 Ohm BNC Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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### **Environmental Specifications**

### ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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